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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

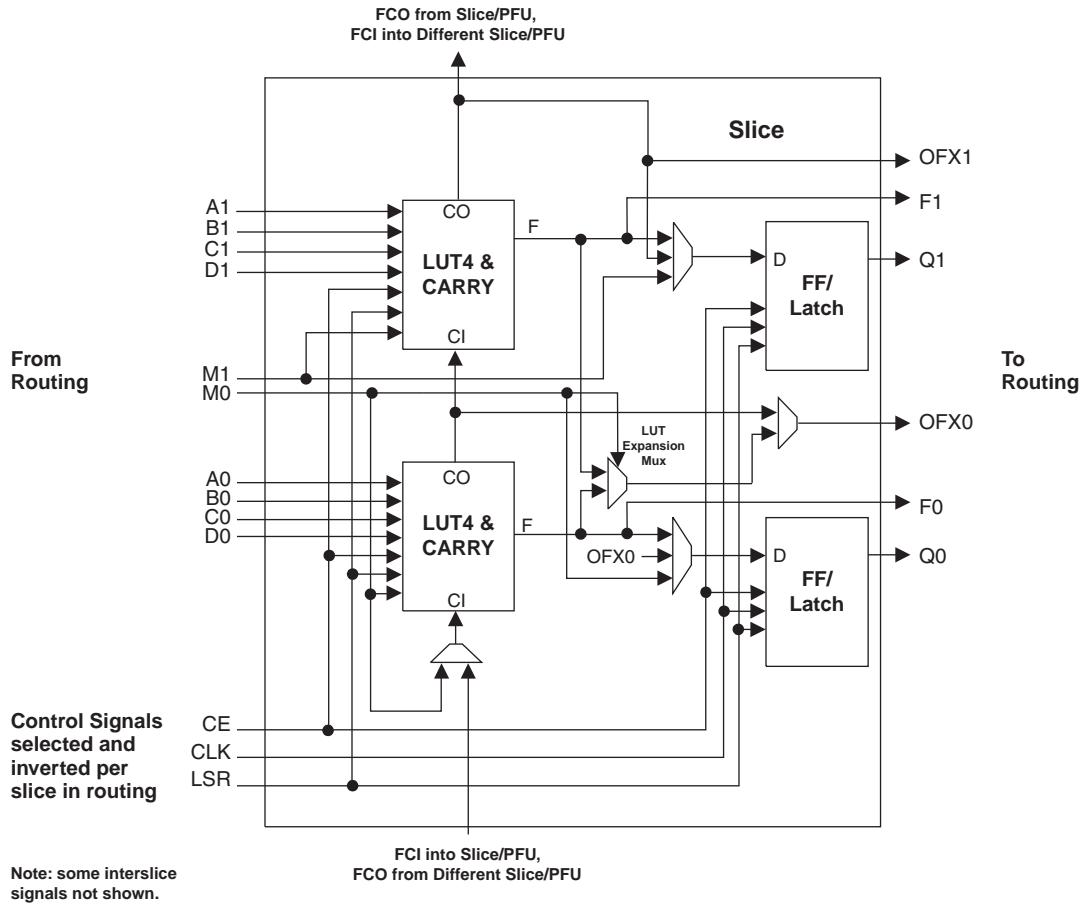
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

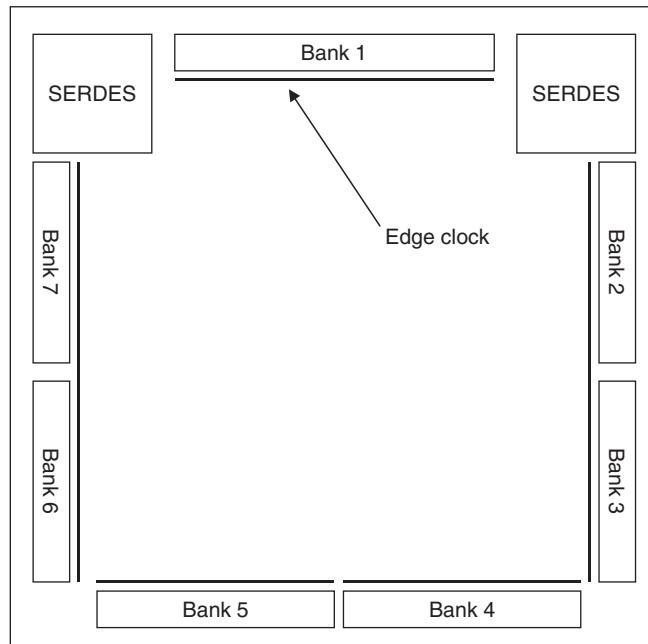
Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	942
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1704-BBGA, FCBGA
Supplier Device Package	1704-OFCBGA (42.5x42.5)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga115ep1-6ffn1704c

Figure 2-3. Slice Diagram**Table 2-1. Slice Signal Descriptions**

Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FCI	Fast Carry In ¹
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register Outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8 ² MUX depending on the slice
Output	Inter-PFU signal	FCO	For the right most PFU the fast carry chain output ²

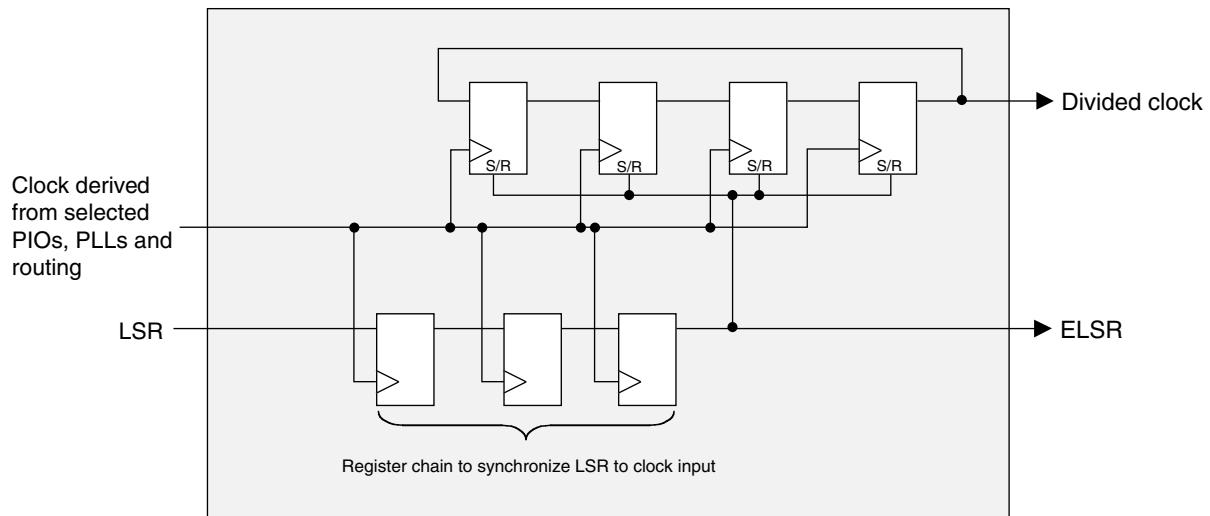
1. See Figure 2-2 for connection details.

2. Requires two PFUs.

Figure 2-7. Edge Clock Resources

Precision Clock Divider

Each set of edge clocks has four high-speed dividers associated with it. These are intended for generating a slower speed system clock from the high-speed edge clock. The block operates in a DIV2 or DIV4 mode and maintains a known phase relationship between the divided down clock and high-speed clock based on the release of its reset signal. The clock dividers can be fed from selected PIOs, PLLs and routing. The clock divider outputs serve as primary clock sources. This circuit also generates an edge local set/reset (ELSR) signal which is fed to the PIOs via the edge clock network and is used for the rest of the I/O gearing logic.

Figure 2-8. Clock Divider Circuit

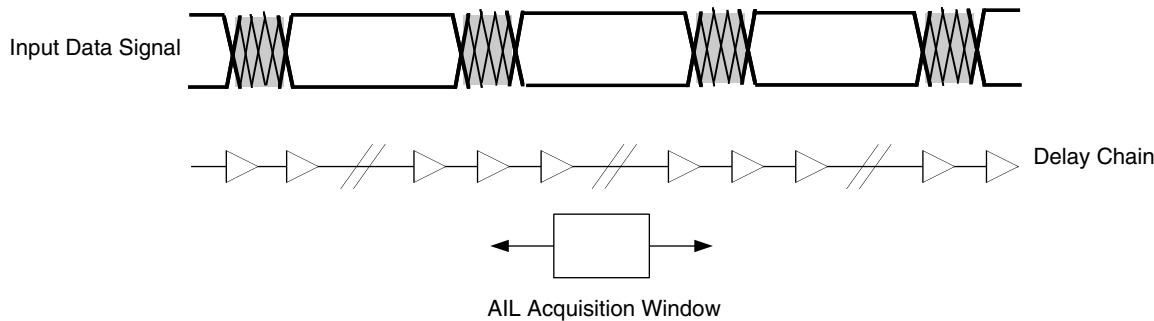
Dynamic Clock Select (DCS)

The DCS is a global clock buffer with smart multiplexer functions. It takes two independent input clock sources and outputs a clock signal without any glitches or runt pulses. This is achieved irrespective of where the select signal is

Adaptive Input Logic (AIL) Overview

The Adaptive Input Logic (AIL) provides the ability of the input logic to dynamically find a solution by monitoring multiple samples of the input data. The input data signal from the input buffer is run through a delay chain. Data, transitions, jitter, noise are all contained inside of the delay chain. The AIL will then search the delay chain for a clean sampling point for data. Once found the AIL will monitor and walk with the data dynamically. This novel approach of using a delay chain to create multiple copies of the data provides a lower power solution than oversampling data with a higher speed clock. Figure 2-19 provides a high level view of the AIL methodology.

Figure 2-19. LatticeSC AIL Delay of Input Data Waveform



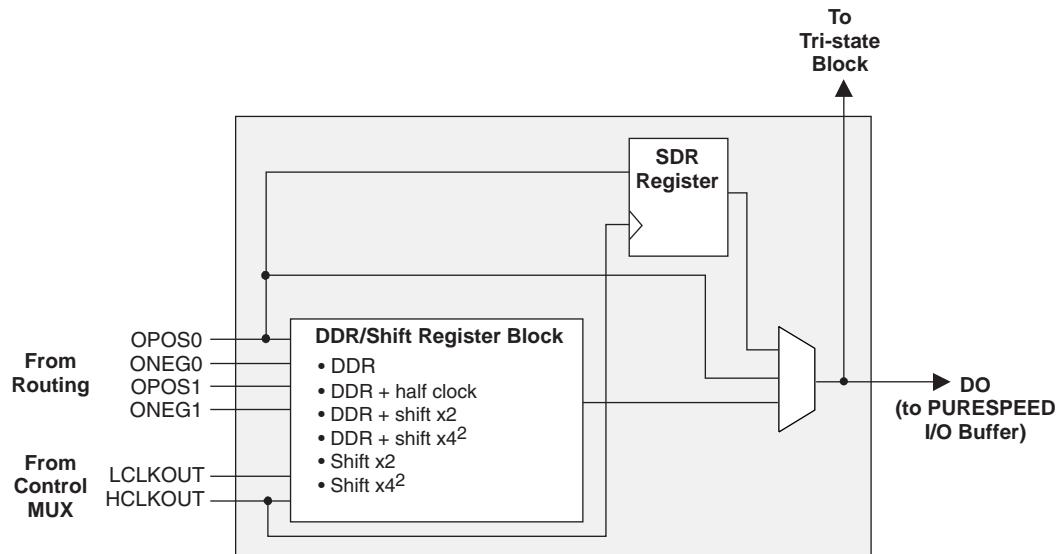
The AIL slides the acquisition window through the delay chain searching for stable data based solely on data transitions. A specific training pattern is not required to perform this bit alignment, simply data transitions. The size of the acquisition window is user-selectable allowing the AIL to operate over the full range of the PURESPEED I/O range. Based on dynamic user control the AIL can either continuously adjust the window location based on data edge detection or it can be locked to a specific delay.

The AIL operates on single data and double data rate interfaces and is available on most FPGA input pins on the LatticeSC device and all buffer types. The AIL block is low power using only 0.003 mW/MHz typical (6 mW @ 2 Gbps) for PRBS 2⁷ data. Multiple AIL inputs can be used to create a bus with a FPGA circuit to realign the bus to a common clock cycle. The FPGA circuit to realign the bus is required and is provided by Lattice as a reference design.

For more information on the LatticeSC AIL please refer to TN1158 [LatticeSC PURESPEED I/O Adaptive Input Logic User's Guide](#).

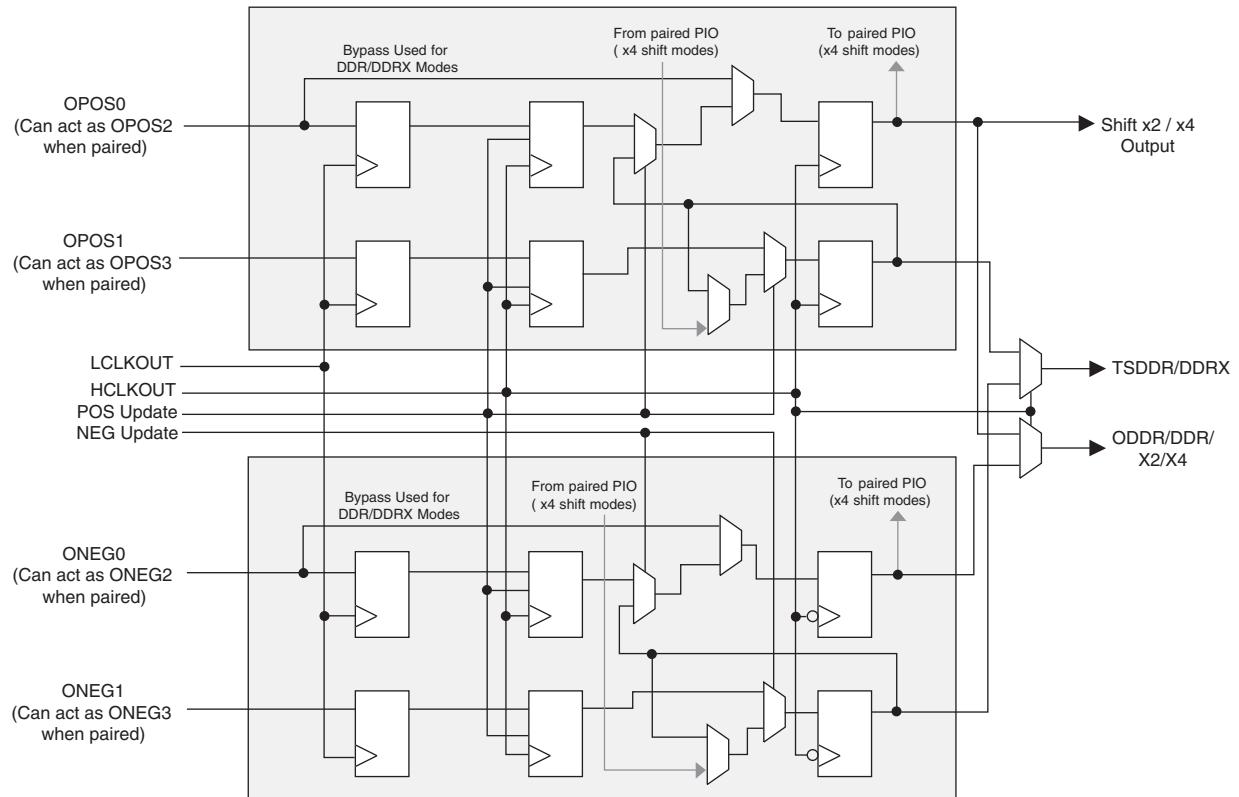
Input DDR/Shift Block

The DDR/Shift block contains registers and associated logic that support DDR and shift register functions using the high-speed clock and the associated transfer to the low-speed clock domain. It functions as a gearbox allowing high-speed incoming data to be passed into the FPGA fabric. Each PIO supports DDR and x2 shift functions. If desired PIOs A and B or C and D can be combined to form x4 shift functions. The PIOs A and C on the left, right and bottom of the device also contain an optional Adaptive Input Logic (AIL) element. This logic automatically aligns incoming data with the clock allowing for easy design of high-speed interfaces. Figure 2-21 shows a simplified block diagram of the shift register block. The shift block in conjunction with the update and clock divider blocks automatically handles the hand off between the low-speed and high-speed clock domains.

Figure 2-22. Output Register Block¹

Notes:

1. CE, Update, Set and Reset not shown for clarity.
2. By four shift modes utilizes DDR/Shift register block from paired PIO.
3. DDR/Shift register block shared with tristate block.

Figure 2-23. Output/Tristate DDR/Shift Register Block

Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of three registers for DDR and shift register operation. The output signal tri-state control signal (TO) can be derived directly from one of the inputs (bypass mode), the SDR shift register, the DDR registers or the data associated with the buffer (for open drain emulation). Figure 2-24 shows the diagram of the Tristate Register Block.

Tristate SDR Register/Latch Block

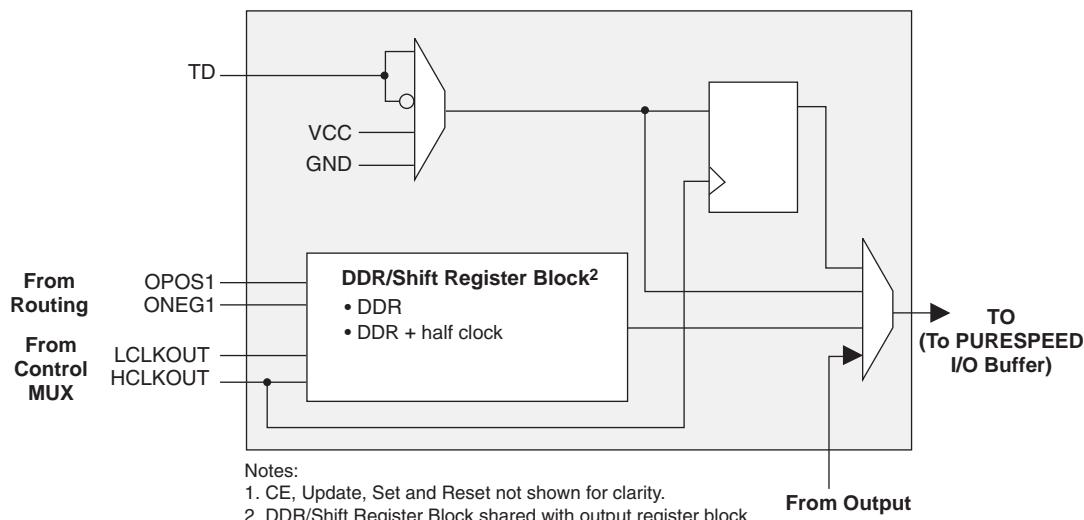
The SDR register operates on the positive edge of the high-speed clock. It has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR input is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Tristate DDR/Shift Register Block

The DDR/Shift block is shared with the output block allowing DDR support using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low-speed parallel data from the FPGA fabric to provide a high-speed tri-state control stream.

There is a special mode for DDR-II memory interfaces where the termination is controlled by the output tristate signal. During WRITE cycle when the FPGA is driving the lines, the parallel terminations are turned off. During READ cycle when the FPGA is receiving data, the parallel terminations are turned on.

Figure 2-24. Tristate Register Block¹



I/O Architecture Rules

Table 2-6 shows the PIO usage for x1, x2, x4 gearing. The checkmarks in the columns show the specific PIOs that are used for each gearing mode. When using x2 or x4 gearing, any PIO which is not used for gearing can still be used as an output.

December 2011

Data Sheet DS1004

Absolute Maximum Ratings

Supply Voltage V_{CC} , V_{CC12} , V_{DDIB} , V_{DDOB}	-0.5 to 1.6V
Supply Voltage V_{CCAUX} , V_{DDAX25} , V_{TT}	-0.5 to 2.75V
Supply Voltage V_{CCJ}	-0.5 to 3.6V
Supply Voltage V_{CCIO} (Banks 1, 4, 5)	-0.5 to 3.6V
Supply Voltage V_{CCIO} (Banks 2, 3, 6, 7)	-0.5 to 2.75V
Input or I/O Tristate Voltage Applied (Banks 1, 4, 5)	-0.5 to 3.6V
Input or I/O Tristate Voltage Applied (Banks 2, 3, 6, 7)	-0.5 to 2.75V
Storage Temperature (Ambient).....	-65 to 150°C
Junction Temperature Under Bias (T_j)	+125°C

Notes:

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
2. Compliance with the Lattice Thermal Management document is required.
3. All voltages referenced to GND.
4. Undershoot and overshoot of -2V to ($VIHMAX + 2$) volts is permitted for a duration of <20ns.

Recommended Operating Conditions

Symbol	Parameter	Min.	Max.	Units
V_{CC}^5	Core Supply Voltage (Nominal 1.2V Operation)	0.95	1.26	V
V_{CCAUX}^6	Programmable I/O Auxiliary Supply Voltage	2.375	2.625	V
$V_{CCIO}^{1, 2, 5, 6}$	Programmable I/O Driver Supply Voltage (Banks 1, 4, 5)	1.14	3.45	V
$V_{CCIO}^{1, 2, 5, 6}$	Programmable I/O Driver Supply Voltage (Banks 2, 3, 6, 7)	1.14	2.625	V
$V_{CC12}^{4, 5}$	Internal 1.2V Power Supply Voltage for Configuration Logic and FPGA PLL, SERDES PLL Power Supply Voltage and SERDES Analog Supply Voltage	1.14	1.26	V
V_{DDIB}	SERDES Input Buffer Supply Voltage	1.14	1.575	V
V_{DDOB}	SERDES Output Buffer Supply Voltage	1.14	1.575	V
V_{DDAX25}	SERDES Termination Auxiliary Supply Voltage	2.375	2.625	V
$V_{CCJ}^{1, 5}$	Supply Voltage for IEEE 1149.1 Test Access Port	1.71	3.45	V
$V_{TT}^{2, 3}$	Programmable I/O Termination Power Supply	0.5	$V_{CCAUX} - 0.5$	V
t_{JCOM}	Junction Temperature, Commercial Operation	0	+85	C
t_{JIND}	Junction Temperature, Industrial Operation	-40	105	C

1. If V_{CCIO} or V_{CCJ} is set to 2.5V, they must be connected to the same power supply as V_{CCAUX} .
2. See recommended voltages by I/O standard in subsequent table.
3. When V_{TT} termination is not required, or used to provide the common mode termination voltage (V_{CMT}), these pins can be left unconnected on the device.
4. V_{CC12} cannot be lower than V_{CC} at any time. For 1.2V operation, it is recommended that the V_{CC} and V_{CC12} supplies be tied together with proper noise decoupling between the digital VCC and analog VCC12 supplies.
5. V_{CC} , V_{CCIO} (all banks), V_{CC12} and V_{CCJ} must reach their minimum values before configuration will proceed.
6. If V_{CCIO} for a bank is nominally 1.2V/1.5V/1.8V, then V_{CCAUX} must always be higher than V_{CCIO} during power up.

Typical Building Block Function Performance

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Pin to Pin Performance (LVCMOS25 12 mA Drive)

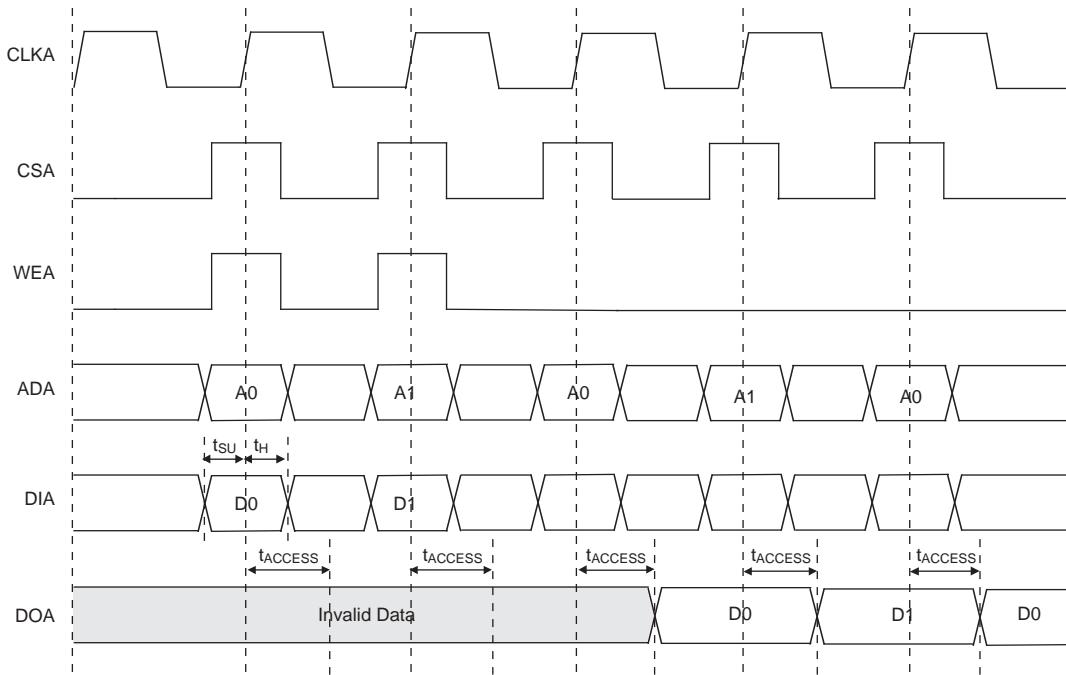
Function	-7*	Units
Basic Functions		
32-bit Decoder	6.65	ns
Combinatorial (Pin to LUT to Pin)	5.58	ns
Embedded Memory Functions (Single Port RAM)		
Pin to EBR Input Register Setup (Global Clock)	1.66	ns
EBR Output Clock to Pin (Global Clock)	8.54	ns
Distributed (PFU) RAM (Single Port RAM)		
Pin to PFU RAM Register Setup (Global Clock)	1.32	ns
PFU RAM Clock to Pin (Global Clock)	6.83	ns

*Typical performance per function

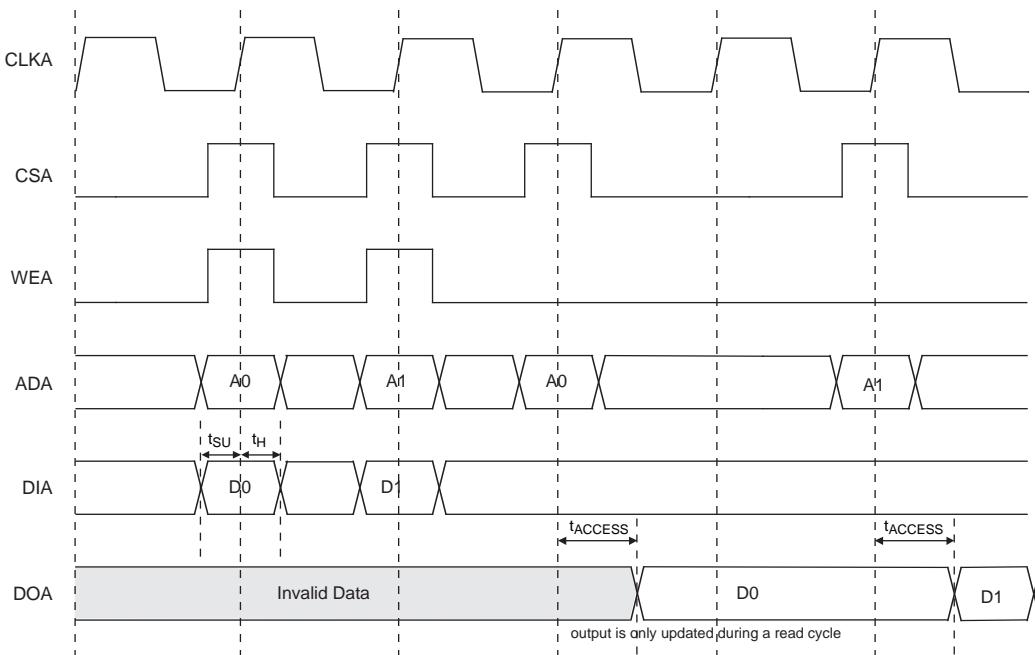
Register-to-Register Performance

Function	-7*	Units
Basic Functions		
32-Bit Decoder	539	MHz
64-Bit Decoder	517	MHz
16:1 MUX	1003	MHz
32:1 MUX	798	MHz
16-Bit Adder	672	MHz
64-Bit Adder	353	MHz
16-Bit Counter	719	MHz
64-Bit Counter	369	MHz
32x8 SP RAM (PFU, Output Registered)	768	MHz
128x8 SP RAM (PFU, Output Registered)	545	MHz
Embedded Memory Functions		
Single Port RAM (512x36 Bits)	372	MHz
True Dual Port RAM 1024x18 Bits (No EBR Out Reg)	326	MHz
True dual port RAM 1024x18 Bits (EBR Reg)	372	MHz
FIFO port (A: x36 bits, B: x9 Bits, No EBR Out Reg)	353	MHz
FIFO port (A: x36 bits, B: x9 Bits, EBR Reg)	375	MHz
True DP RAM Width Cascading (1024x72)	372	MHz
DSP Functions		
9x9 1-stage Multiplier	209	MHz
18x18 1-Stage Multiplier	155	MHz
9x9 3-Stage Pipelined Multiplier	373	MHz
18x18 4-Stage Pipelined Multiplier	314	MHz
9x9 Constant Multiplier	372	MHz

*Typical performance per function

EBR Memory Timing Diagrams**Figure 3-6. Read Mode**

Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive edge of the clock.

Figure 3-7. Read Mode with Input Registers Only

LatticeSC/M sysCONFIG Port Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
General Configuration Timing				
$t_{S MODE}$	M[3:0] Setup Time to INITN High	0	—	ns
$t_{H MODE}$	M[3:0] Hold Time from INITN High	600	—	ns
t_{RW}	RESETN Pulse Width Low to Start Reconfiguration (1.2 V)	50 (or 100 at 0.95V)	—	ns
t_{PGW}	PROGRAMN Pulse Width Low to Start Reconfiguration (1.2 V)	50 (or 100 at 0.95V)	—	ns
$f_{ESB_CLK_FRQ}$	System Bus ESB_CLK Frequency (No Wait States)	—	133	MHz
sysCONFIG Master Parallel Configuration Mode				
t_{SMB}	D[7:0] Setup Time to RCLK High	6	—	ns
t_{HMB}	D[7:0] Hold Time to RCLK High	0	—	ns
t_{CLMB}	RCLK Low Time (Non-compressed Bitstreams)	0.5	0.5	CCLK periods
	RCLK Low Time (Compressed Bitstreams)	0.5	7.5	CCLK periods
t_{CHMB}	RCLK High Time	0.5	0.5	CCLK periods
sysCONFIG SPI Port				
t_{CFGX}	INITN High to CSCK Low	—	80	ns
t_{CSSPI}	INITN High to CSSPIN Low	0	2	μs
t_{SCK}	CSCK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CSCK Low to Output Valid	—	15	ns
t_{CSPID}	CSSPIN Low to CSCK high Setup Time	—	15	ns
f_{MAXSPI}	Max CCLK Frequency - SPI Flash Fast Read Opcode (0x0B) (SPIFASTN=0)	—	50	MHz
t_{SUSPI}	SOSPI/D0 Data Setup Time Before CSCK	7	—	ns
t_{HSPI}	SOSPI/D0 Data Hold Time After CSCK	2	—	ns
	Master Clock Frequency	Selected value - 30%	Selected value + 30%	MHz
	Duty Cycle	40	60	%
sysCONFIG Master Serial Configuration Mode				
t_{SMS}	DIN Setup Time	4.4	—	ns
t_{HMS}	DIN Hold Time	0	—	ns
f_{CMS}	CCLK Frequency (No Divider)	90	190	MHz
f_{C_DIV}	CCLK Frequency (Div 128)	0.70	1.48	MHz
t_D	CCLK to DOUT Delay	—	7.5	ns
sysCONFIG Master Parallel Configuration Mode				
t_{AVMP}	RCLK to Address Valid	—	10	ns
t_{SMP}	D[7:0] Setup Time to RCLK High	6	—	ns
t_{HMP}	D[7:0] Hold Time to RCLK High	0	—	ns
t_{CLMP}	RCLK Low Time (Non-compressed Bitstream)	7.5	7.5	CCLK periods
	RCLK Low Time (Compressed Bitstream)	0.5	63.5	CCLK periods
t_{CHMP}	RCLK High Time	0.5	0.5	CCLK periods
t_{DMP}	CCLK to DOUT	—	7.5	ns

Signal Descriptions (Cont.)

Signal Name	I/O	Description
RESETN		Reset. (Also sent to general routing). During configuration it resets the configuration state machine. After configuration this pin can perform the global set/reset (GSR) functions or can be used as a general input pin.
CFGIRQN	O	MPI Interrupt request active low signal is controlled by system bus interrupt controller and may be sourced from any bus error or MPI configuration error. It can be connected to one of MPC860 IRQ pins.
TSALLN	I	Tristates all I/O.
Configuration Pads (User I/O if not used. Used during sysCONFIG.)		
HDC/SI	O	<p>High During Configuration is output high until configuration is complete. It is used as a control output, indicating that configuration is not complete.</p> <p>For SPI modes, this pin is used to download the read command and initial read address into the Flash memory device on the falling edge of SCK. This pin will be connected to SI of the memory. If the SPI mode is used, the 8-bit instruction code 0x03 will be downloaded followed by a 24-bit starting address of 0x000000 or a non-zero stat address for partial reconfiguration. If the SPIX mode has been selected, the 8-bit instruction captured on D[7:0] at power-up will be shifted in and followed by a 32-bit starting address of 0x000000.</p>
LDCN/SCS	O	<p>Low During Configuration is output low until configuration is complete. It is used as a control output, indicating that configuration is not complete.</p> <p>For SPI modes, this is an active low chip select for Flash memories. It will go active after INITN goes high but before SCK begins. During power up LDCN will be low. Once INITN goes high, LDCN will go high for 100ns-200ns after which time it will go back low and configuration can begin. During the 100ns-200ns period, the read instruction will be latched for SPIX mode.</p>
DOUT	O	Serial data output that can drive the D0/DIN of daisy-chained slave devices. The data-stream from this output will propagate preamble bits of the bitstream to daisy-chained devices. Data out on DOUT changes on the rising edge of CCLK.
QOUT/CEON	O	<p>During daisy-chaining configuration, QOUT is the serial data output that can drive the D0/DIN of daisy-chained slave devices that do not propagate preamble bits. Data out on QOUT changes on the rising edge of CCLK.</p> <p>During parallel-chaining configuration, active low CEON enables the cascaded slave device to receive bitstream data.</p>
RDN	I	Used in the asynchronous peripheral configuration mode. A low on RDN changes D[7:3] into status outputs. WRN and RDN should not be used simultaneously. If they are, the write strobe overrides.
WRN	I	When the FPGA is selected, a low on the write strobe, WRN, loads the data on D[7:0] inputs into an internal data buffer.
CS0N CS1	I	Used in the asynchronous peripheral, slave parallel and MPI modes. The FPGA is selected when CS0N is low and CS1 is high. During configuration, a pull-up is enabled on both except with MPI DMA access control.
A[21:0]	I/O	In master parallel mode, A[21:0] is an output and will address the configuration EPROMs up to 4 MB space. For MPI configuration mode, A[17:0] will be the MPI address MPI_ADDR[31:14], A[19:18] will be the transfer size and A[21:20] will be the burst mode and burst in process.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
F19	PT37D	1	WRN/MPI_WR_N	PT46D	1	WRN/MPI_WR_N
F18	PT37C	1	D7/MPI_DATA7	PT46C	1	D7/MPI_DATA7
C18	PT37B	1	D6/MPI_DATA6	PT46B	1	D6/MPI_DATA6
C17	PT37A	1	D5/MPI_DATA5	PT46A	1	D5/MPI_DATA5
E17	PT36D	1	D4/MPI_DATA4	PT45D	1	D4/MPI_DATA4
E16	PT36C	1	D3/MPI_DATA3	PT45C	1	D3/MPI_DATA3
G18	PT35B	1	D2/MPI_DATA2	PT45B	1	D2/MPI_DATA2
G17	PT35A	1	D1/MPI_DATA1	PT45A	1	D1/MPI_DATA1
B18	PT33B	1	D0/MPI_DATA0	PT43B	1	D0/MPI_DATA0
B17	PT33A	1	QOUT/CEON	PT43A	1	QOUT/CEON
G16	PT32D	1	VREF2_1	PT42D	1	VREF2_1
A18	PT32B	1	DOUT	PT42B	1	DOUT
A17	PT32A	1	MCA_DONE_IN	PT42A	1	MCA_DONE_IN
H18	PT31B	1	MCA_CLK_P1_OUT	PT41B	1	MCA_CLK_P1_OUT
H17	PT31A	1	MCA_CLK_P1_IN	PT41A	1	MCA_CLK_P1_IN
D17	PT29B	1	MCA_CLK_P2_OUT	PT39B	1	MCA_CLK_P2_OUT
D16	PT29A	1	MCA_CLK_P2_IN	PT39A	1	MCA_CLK_P2_IN
F17	PT28D	1	MCA_DONE_OUT	PT38D	1	MCA_DONE_OUT
F16	PT28C	1	BUSYN/RCLK/SCK	PT38C	1	BUSYN/RCLK/SCK
C16	PT28B	1	DP0/MPI_PAR0	PT38B	1	DP0/MPI_PAR0
C15	PT28A	1	MPI_TA	PT38A	1	MPI_TA
B16	PT27B	1	PCLKC1_0	PT37B	1	PCLKC1_0
B15	PT27A	1	PCLKT1_0/MPI_CLK	PT37A	1	PCLKT1_0/MPI_CLK
H16	PT25D	1	DP3/PCLKC1_4/MPI_PAR3	PT35D	1	DP3/PCLKC1_4/MPI_PAR3
A16	PT25B	1	MPI_RETRY	PT35B	1	MPI_RETRY
A15	PT25A	1	A0/MPI_ADDR14	PT35A	1	A0/MPI_ADDR14
G15	PT24D	1	A1/MPI_ADDR15	PT33D	1	A1/MPI_ADDR15
F15	PT24C	1	A2/MPI_ADDR16	PT33C	1	A2/MPI_ADDR16
E15	PT24B	1	A3/MPI_ADDR17	PT33B	1	A3/MPI_ADDR17
D15	PT24A	1	A4/MPI_ADDR18	PT33A	1	A4/MPI_ADDR18
C14	PT23B	1	A5/MPI_ADDR19	PT32B	1	A5/MPI_ADDR19
C13	PT23A	1	A6/MPI_ADDR20	PT32A	1	A6/MPI_ADDR20
H14	PT21C	1	VREF1_1	PT31C	1	VREF1_1
B14	PT21B	1	A7/MPI_ADDR21	PT31B	1	A7/MPI_ADDR21
B13	PT21A	1	A8/MPI_ADDR22	PT31A	1	A8/MPI_ADDR22
G14	PT20B	1	A9/MPI_ADDR23	PT29B	1	A9/MPI_ADDR23
F14	PT20A	1	A10/MPI_ADDR24	PT29A	1	A10/MPI_ADDR24
A14	PT19B	1	A11/MPI_ADDR25	PT28B	1	A11/MPI_ADDR25
A13	PT19A	1	A12/MPI_ADDR26	PT28A	1	A12/MPI_ADDR26
G13	PT17D	1	D11/MPI_DATA11	PT27D	1	D11/MPI_DATA11
H13	PT17C	1	D12/MPI_DATA12	PT27C	1	D12/MPI_DATA12
E14	PT17B	1	A13/MPI_ADDR27	PT27B	1	A13/MPI_ADDR27
E13	PT17A	1	A14/MPI_ADDR28	PT27A	1	A14/MPI_ADDR28
G12	PT15D	1	A16/MPI_ADDR30	PT25D	1	A16/MPI_ADDR30
G11	PT15C	1	D13/MPI_DATA13	PT25C	1	D13/MPI_DATA13

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1,2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
N17	GND	-		GND	-	
N18	GND	-		GND	-	
N19	GND	-		GND	-	
N20	GND	-		GND	-	
P11	GND	-		GND	-	
P12	GND	-		GND	-	
P13	GND	-		GND	-	
P14	GND	-		GND	-	
P15	GND	-		GND	-	
P16	GND	-		GND	-	
P17	GND	-		GND	-	
P18	GND	-		GND	-	
P19	GND	-		GND	-	
P20	GND	-		GND	-	
R10	GND	-		GND	-	
R11	GND	-		GND	-	
R12	GND	-		GND	-	
R13	GND	-		GND	-	
R14	GND	-		GND	-	
R15	GND	-		GND	-	
R16	GND	-		GND	-	
R17	GND	-		GND	-	
R18	GND	-		GND	-	
R19	GND	-		GND	-	
R20	GND	-		GND	-	
R21	GND	-		GND	-	
T10	GND	-		GND	-	
T11	GND	-		GND	-	
T12	GND	-		GND	-	
T13	GND	-		GND	-	
T14	GND	-		GND	-	
T15	GND	-		GND	-	
T16	GND	-		GND	-	
T17	GND	-		GND	-	
T18	GND	-		GND	-	
T19	GND	-		GND	-	
T20	GND	-		GND	-	
T21	GND	-		GND	-	
U11	GND	-		GND	-	
U12	GND	-		GND	-	
U13	GND	-		GND	-	
U14	GND	-		GND	-	
U15	GND	-		GND	-	
U16	GND	-		GND	-	
U17	GND	-		GND	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P32	PL30A	6		PL39A	6	
P31	PL30B	6		PL39B	6	
R28	PL30C	6	PCLKT6_3	PL39C	6	PCLKT6_3
T28	PL30D	6	PCLKC6_3	PL39D	6	PCLKC6_3
R30	PL31A	6		PL40A	6	
R29	PL31B	6		PL40B	6	
T25	PL31C	6	PCLKT6_2	PL40C	6	PCLKT6_2
T26	PL31D	6	PCLKC6_2	PL40D	6	PCLKC6_2
R31	PL34A	6		PL43A	6	
R32	PL34B	6		PL43B	6	
U23	PL34C	6	VREF1_6	PL43C	6	VREF1_6
U24	PL34D	6		PL43D	6	
T31	PL35A	6		PL44A	6	
T32	PL35B	6		PL44B	6	
T27	PL35C	6		PL44C	6	
U28	PL35D	6		PL44D	6	
U32	PL36A	6		PL45A	6	
U31	PL36B	6		PL45B	6	
U26	PL36C	6		PL45C	6	
U25	PL36D	6		PL45D	6	
V32	PL38A	6		PL47A	6	
V31	PL38B	6		PL47B	6	
V24	PL38C	6		PL47C	6	
V23	PL38D	6		PL47D	6	
V29	PL39A	6		PL48A	6	
V30	PL39B	6		PL48B	6	
U27	PL39C	6		PL48C	6	
V28	PL39D	6		PL48D	6	
W30	PL40A	6		PL49A	6	
W29	PL40B	6		PL49B	6	
V25	PL40C	6		PL49C	6	
W26	PL40D	6		PL49D	6	
W31	PL42A	6		PL51A	6	
Y31	PL42B	6		PL51B	6	
W27	PL42C	6		PL51C	6	
Y27	PL42D	6	DIFFR_6	PL51D	6	DIFFR_6
W28	PL43A	6		PL52A	6	
Y28	PL43B	6		PL52B	6	
Y26	PL43C	6		PL52C	6	
W25	PL43D	6		PL52D	6	
W32	PL44A	6		PL53A	6	
Y32	PL44B	6		PL53B	6	
AB28	PL44C	6		PL53C	6	
AA28	PL44D	6		PL53D	6	
AB32	PL47A	6		PL60A	6	
AA32	PL47B	6		PL60B	6	
AB27	PL47C	6		PL60C	6	
AC27	PL47D	6		PL60D	6	
AD31	PL48A	6		PL61A	6	
AC31	PL48B	6		PL61B	6	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P10	GND	-		GND	-	
P13	GND	-		GND	-	
P15	GND	-		GND	-	
P18	GND	-		GND	-	
P20	GND	-		GND	-	
P24	GND	-		GND	-	
R12	GND	-		GND	-	
R14	GND	-		GND	-	
R16	GND	-		GND	-	
R17	GND	-		GND	-	
R19	GND	-		GND	-	
R21	GND	-		GND	-	
R26	GND	-		GND	-	
R6	GND	-		GND	-	
T15	GND	-		GND	-	
T18	GND	-		GND	-	
T30	GND	-		GND	-	
T4	GND	-		GND	-	
U15	GND	-		GND	-	
U18	GND	-		GND	-	
U29	GND	-		GND	-	
U3	GND	-		GND	-	
V12	GND	-		GND	-	
V14	GND	-		GND	-	
V16	GND	-		GND	-	
V17	GND	-		GND	-	
V19	GND	-		GND	-	
V21	GND	-		GND	-	
V27	GND	-		GND	-	
V7	GND	-		GND	-	
W13	GND	-		GND	-	
W15	GND	-		GND	-	
W18	GND	-		GND	-	
W20	GND	-		GND	-	
W23	GND	-		GND	-	
W9	GND	-		GND	-	
Y12	GND	-		GND	-	
Y14	GND	-		GND	-	
Y19	GND	-		GND	-	
Y21	GND	-		GND	-	
Y30	GND	-		GND	-	
Y4	GND	-		GND	-	
N13	VCC	-		VCC	-	
N15	VCC	-		VCC	-	
N16	VCC	-		VCC	-	
N17	VCC	-		VCC	-	
N18	VCC	-		VCC	-	
N20	VCC	-		VCC	-	
P14	VCC	-		VCC	-	
P16	VCC	-		VCC	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AJ34	PL98A	6	
AK34	PL98B	6	
AB27	PL98C	6	
AC27	PL98D	6	
AF33	PL99A	6	
AG33	PL99B	6	
AC29	PL99C	6	
AD29	PL99D	6	
AE31	PL103A	6	
AF31	PL103B	6	
AF30	PL103C	6	
AF29	PL103D	6	
AH33	PL104A	6	
AJ33	PL104B	6	
AC28	PL104C	6	
AD28	PL104D	6	
AH32	PL107A	6	
AJ32	PL107B	6	
AD27	PL107C	6	
AE27	PL107D	6	VREF2_6
AG34	PL109A	6	
AH34	PL109B	6	
AC26	PL109C	6	
AB26	PL109D	6	
AK33	PL112A	6	
AL33	PL112B	6	
AG30	PL112C	6	
AH30	PL112D	6	
AL34	PL115A	6	
AM34	PL115B	6	
AJ30	PL115C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AK30	PL115D	6	LLC_DLCC_IN_E/LLC_DLCC_FB_F
AJ31	PL116A	6	
AH31	PL116B	6	
AD26	PL116C	6	
AD25	PL116D	6	
AL32	PL117A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AL31	PL117B	6	LLC_DLCC_IN_F/LLC_DLCC_FB_E
AG29	PL117C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AG28	PL117D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AF28	XRES	-	
AF27	TEMP	6	
AM33	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AN15	PB89A	4	PCLKT4_2
AN14	PB89B	4	PCLKC4_2
AE16	PB89C	4	PCLKT4_7
AD16	PB89D	4	PCLKC4_7
AK15	PB90A	4	PCLKT4_1
AK14	PB90B	4	PCLKC4_1
AG15	PB90C	4	PCLKT4_6
AG14	PB90D	4	PCLKC4_6
AM13	PB91A	4	PCLKT4_0
AM12	PB91B	4	PCLKC4_0
AJ12	PB91C	4	VREF2_4
AJ11	PB91D	4	
AL13	PB93A	4	PCLKT4_5
AL12	PB93B	4	PCLKC4_5
AH12	PB93C	4	
AH11	PB93D	4	
AN13	PB94A	4	PCLKT4_3
AN12	PB94B	4	PCLKC4_3
AD14	PB94C	4	PCLKT4_4
AD15	PB94D	4	PCLKC4_4
AP13	PB87A	4	
AP12	PB87B	4	
AK13	PB87C	4	
AK12	PB87D	4	
AP11	PB97A	4	
AP10	PB97B	4	
AN11	PB113A	4	
AN10	PB113B	4	
AF14	PB113C	4	
AF13	PB113D	4	
AM10	PB115A	4	
AM9	PB115B	4	
AE14	PB115C	4	
AE13	PB115D	4	
AP9	PB118A	4	
AP8	PB118B	4	
AK11	PB118C	4	
AK10	PB118D	4	
AL10	PB121A	4	
AL9	PB121B	4	
AF12	PB121C	4	
AF11	PB121D	4	
AN9	PB123A	4	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AN8	PB123B	4	
AG11	PB123C	4	
AG10	PB123D	4	
AP7	PB125A	4	
AP6	PB125B	4	
AG13	PB125C	4	
AG12	PB125D	4	
AN7	PB127A	4	
AN6	PB127B	4	
AK9	PB127C	4	
AK8	PB127D	4	
AP5	PB129A	4	
AP4	PB129B	4	
AD11	PB129C	4	
AE11	PB129D	4	
AM7	PB131A	4	
AM6	PB131B	4	
AJ9	PB131C	4	
AJ8	PB131D	4	
AP3	PB133A	4	
AN3	PB133B	4	
AF10	PB133C	4	
AE10	PB133D	4	
AL7	PB135A	4	
AL6	PB135B	4	
AK7	PB135C	4	
AK6	PB135D	4	
AN5	PB138A	4	
AN4	PB138B	4	
AH9	PB138C	4	VREF1_4
AH8	PB138D	4	
AM3	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AM4	PB139B	4	LRC_DLCC_IN_C/LRC_DLCC_FB_D
AG9	PB139C	4	
AG8	PB139D	4	
AN2	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AM2	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AJ6	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AH6	PB141D	4	LRC_DLCC_IN_D/LRC_DLCC_FB_C
AF7	PROBE_VCC	-	
AF8	PROBE_GND	-	
AG7	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AG6	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AP8	PB117D	4		PB131D	4	
AY3	PB119A	4		PB133A	4	
AW3	PB119B	4		PB133B	4	
AR6	PB119C	4		PB133C	4	
AR5	PB119D	4		PB133D	4	
AU5	PB120A	4		PB134A	4	
AV5	PB120B	4		PB134B	4	
AL12	PB120C	4		PB134C	4	
AL11	PB120D	4		PB134D	4	
AV3	PB121A	4		PB135A	4	
AV4	PB121B	4		PB135B	4	
AN9	PB121C	4		PB135C	4	
AN8	PB121D	4		PB135D	4	
AW1	PB123A	4		PB138A	4	
AY1	PB123B	4		PB138B	4	
AK14	PB123C	4	VREF1_4	PB138C	4	VREF1_4
AK13	PB123D	4		PB138D	4	
AV2	PB124A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB139A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AW2	PB124B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D	PB139B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AM10	PB124C	4		PB139C	4	
AM9	PB124D	4		PB139D	4	
AV1	PB125A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB141A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AU1	PB125B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB141B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AL10	PB125C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB141C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AL9	PB125D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB141D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AT3	PROBE_VCC	-		PROBE_VCC	-	
AU2	PROBE_GND	-		PROBE_GND	-	
AP7	PR95D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR117D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AN7	PR95C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR117C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AR3	PR95B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR117B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AR4	PR95A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR117A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AP6	PR94D	3		PR116D	3	
AN6	PR94C	3		PR116C	3	
AT2	PR94B	3		PR116B	3	
AR2	PR94A	3		PR116A	3	
AM6	PR93D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR115D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AL6	PR93C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR115C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AP5	PR93B	3		PR115B	3	
AN5	PR93A	3		PR115A	3	
AL8	PR91D	3		PR112D	3	
AK8	PR91C	3		PR112C	3	
AP2	PR91B	3		PR112B	3	
AN2	PR91A	3		PR112A	3	
AJ12	PR90D	3		PR109D	3	
AH12	PR90C	3		PR109C	3	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1,2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D1	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
F1	VCC12	-		VCC12	-	
A3	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
E1	A_VDDOB0_R	-		A_VDDOB0_R	-	
B3	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
C2	A_VDDOB1_R	-		A_VDDOB1_R	-	
A4	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
B2	VCC12	-		VCC12	-	
B4	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
E3	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
D3	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
M10	VCC12	-		VCC12	-	
E2	A_VDDIB1_R	-		A_VDDIB1_R	-	
J11	VCC12	-		VCC12	-	
M11	A_VDDIB2_R	-		A_VDDIB2_R	-	
D4	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
E4	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
K9	VCC12	-		VCC12	-	
A5	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
D2	A_VDDOB2_R	-		A_VDDOB2_R	-	
B5	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
L10	A_VDDOB3_R	-		A_VDDOB3_R	-	
B6	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
G6	VCC12	-		VCC12	-	
A6	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
E5	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
D5	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
K12	VCC12	-		VCC12	-	
L13	A_VDDIB3_R	-		A_VDDIB3_R	-	
N14	VCC12	-		VCC12	-	
F9	B_VDDIB0_R	-		B_VDDIB0_R	-	
D6	B_HDINP0_R	-	PCS 3E1 CH 0 IN P	B_HDINP0_R	-	PCS 3E1 CH 0 IN P
E6	B_HDINN0_R	-	PCS 3E1 CH 0 IN N	B_HDINN0_R	-	PCS 3E1 CH 0 IN N
J8	VCC12	-		VCC12	-	
B7	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P	B_HDOUTP0_R	-	PCS 3E1 CH 0 OUT P
G4	B_VDDOB0_R	-		B_VDDOB0_R	-	
A7	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N	B_HDOUTN0_R	-	PCS 3E1 CH 0 OUT N
K8	B_VDDOB1_R	-		B_VDDOB1_R	-	
A8	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N	B_HDOUTN1_R	-	PCS 3E1 CH 1 OUT N
L9	VCC12	-		VCC12	-	
B8	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P	B_HDOUTP1_R	-	PCS 3E1 CH 1 OUT P
E7	B_HDINN1_R	-	PCS 3E1 CH 1 IN N	B_HDINN1_R	-	PCS 3E1 CH 1 IN N
D7	B_HDINP1_R	-	PCS 3E1 CH 1 IN P	B_HDINP1_R	-	PCS 3E1 CH 1 IN P
F10	VCC12	-		VCC12	-	
K13	B_VDDIB1_R	-		B_VDDIB1_R	-	

Industrial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-6F256I	-6	fpBGA	256	IND	15.2
LFSC3GA15E-5F256I	-5	fpBGA	256	IND	15.2
LFSC3GA15E-6F900I	-6	fpBGA	900	IND	15.2
LFSC3GA15E-5F900I	-5	fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-6F256I	-6	fpBGA	256	IND	15.2
LFSCM3GA15EP1-5F256I	-5	fpBGA	256	IND	15.2
LFSCM3GA15EP1-6F900I	-6	fpBGA	900	IND	15.2
LFSCM3GA15EP1-5F900I	-5	fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-6F900I	-6	fpBGA	900	IND	25.4
LFSC3GA25E-5F900I	-5	fpBGA	900	IND	25.4
LFSC3GA25E-6FF1020I ¹	-6	Organic fcBGA	1020	IND	25.4
LFSC3GA25E-5FF1020I ¹	-5	Organic fcBGA	1020	IND	25.4
LFSC3GA25E-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	25.4
LFSC3GA25E-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-6F900I	-6	fpBGA	900	IND	25.4
LFSCM3GA25EP1-5F900I	-5	fpBGA	900	IND	25.4
LFSCM3GA25EP1-6FF1020I ¹	-6	Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-5FF1020I ¹	-5	Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	25.4
LFSCM3GA25EP1-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-6FF1020I ¹	-6	Organic fcBGA	1020	IND	40.4
LFSC3GA40E-5FF1020I ¹	-5	Organic fcBGA	1020	IND	40.4
LFSC3GA40E-6FFA1020I	-6	Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-5FFA1020I	-5	Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-6FC1152I ²	-6	Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-5FC1152I ²	-5	Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-6FF1152I	-6	Organic fcBGA	1152	IND	40.4
LFSC3GA40E-5FF1152I	-5	Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per [PCN #02A-10](#).

2. Converted to organic flip-chip BGA package per [PCN #01A-10](#).